

UNITED STATES PATENT AND TRADEMARK OFFICE  
**CERTIFICATE OF CORRECTION**

PATENT NO. : 6,890,794 B2  
APPLICATION NO. : 10/765811  
DATED : May 10, 2005  
INVENTOR(S) : Eran Rotem

Page 1 of 1

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

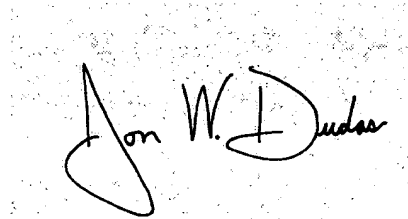
ON THE PATENT FACE

In the Abstract, (57) Line 4: Delete "including" after "die"

Title: (54) Delete "FLIP CHIP WITH NOVEL POWER AND GROUND  
ARRANGEMENT" and insert -- METHOD OF FORMING A  
FLIP CHIP --

Signed and Sealed this

Twenty-first Day of November, 2006

A handwritten signature in black ink, reading "Jon W. Dudas". The signature is stylized, with the first name "Jon" and last name "Dudas" clearly legible, and "W." in the middle. The signature is written over a faint, dotted rectangular area.

JON W. DUDAS  
*Director of the United States Patent and Trademark Office*